No.: RMC-K-HTS-0006 /14

Date: 2024. 8. 19

# Data sheet

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

Style: RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

# RoHS COMPLIANCE ITEM Halogen and Antimony Free

Note: •Stock conditions

Temperature:  $+5^{\circ}C \sim +35^{\circ}C$ Relative humidity:  $25\% \sim 75\%$ 

The period of guarantee: Within 2 year from shipment by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

No: RMC-K-HTS-0006 /14

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 1/18

#### 1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type, style of RMC1/32, 1/20, 1/16S, 1/16, 1/10, 1/8, 1/4, 1/2, 1.

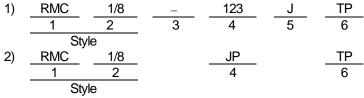
# 1.2 Applicable documents

JIS C 5201–1:2011, JIS C 5201–8:2014, JIS C 5201–8–1: 2014 IEC60115–1:2008, IEC60115–8: 2009, IEC60115–8–1: 2014 EIAJ RC–2134C–2010

# 2. Classification

Type designation shall be the following form.

(Example)



1 Fixed thick film chip resistors; rectangular type

2 Rated dissipation and / or dimension 3 Temperature coefficient of resistance

K	±100×10 <sup>-6</sup> / °C
-(Dash)	Standard

#### 4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
	_	1022> 10.2kΩ
JP	Chip jumper	

#### 5 Tolerance on rated resistance

В	±0.1%
D	±0.5%
F	±1%
G	±2%
J	±5%

# 6 Packaging form 1. Scope

_						
	PA	Press pocket taping				
	TH	Paper taning				
	TP	Paper taping				
	TE	Embossed taping				

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 2/18

### 3. Rating

The ratings shall be in accordance with Table–1.

#### 3.1 Resistor

Table-1(1)

Table–1(1)						
Style	Rated dissipation (W)	Temperature coefficient of resistance (10 <sup>-6</sup> /°C)		Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance
	(/		±200	100~1M		
			±300	10~91	E24, 96	F(±1%)
DN 40 4 /00	0.00		+600~-200	4.7~9.1		,
RMC1/32	0.03	Standard	±200	100~1M		
			±300	10~91	E24	J(±5%)
			+600~-200	1.0~9.1		, ,
			±200	100~510k		B(±0.1%)
			±200	10~1M		D(±0.5%)
			±200	10~10M	E24, 96	,
			+350~-100	4.02~9.76		F(±1%)
RMC1/20	0.05	Standard	+600~-200	1.0~3.92	1	,
			±200	10~1M		G(±2%)
			±200	10~10M		- ( ' ' ' ' ' '
			+350~-100	4.3~9.1	E24	J(±5%)
			+600~-200	1.0~3.9	-	3(2373)
		К	±100	100~510k	504.00	B(±0.1%)
		Standard	±200	1.02M~3.3M		
	0.1	К	±100	10~1M		D(±0.5%)
		Standard	±200	1.02M~10M	E24, 96	
RMC1/16S		К	±100	10~1M		F(±1%)
		Standard	+500~-200	1~9.76		, ,
			±200	10~3.3M	E24	G(±2%)
			±200	10~10M		, ,
			+500~-200	1~9.1		J(±5%)
	0.1		±100	100~510k		B(±0.1%)
		К	±100	10~3.3M	E24, 96	D(±0.5%)
			±100	10~10M		,
			+500~-200	1.0~9.76	1	F(±1%)
RMC1/16			±200	10~10M		0( 00()
		Standard	+500~-200	1.0~9.1	1	G(±2%)
			±200	10~22M	E24	
			+500~-200	1.0~9.1	1	J(±5%)
		К	±100	100~510k		B(±0.1%)
		Standard	±200	2.21M~3.3M	1	,
		K	±100	10~2.2M	1	D(±0.5%)
		Standard	±200	2.21M~10M	E24, 96	
		K	±100	10~2.2M	1	F(±1%)
RMC1/10	0.125	1.	+500~-200	1.0~9.76	-	( - / - /
			±200	10~10M		
		Standard	+500~-200	1.0~9.1	1 _	G(±2%)
		2.3	±200	10~22M	E24	J(±5%)
			+500~-200	1.0~9.1	1	

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 3/18

# Table-1(2)

Style	Rated dissipation (W)	Temperature coefficient of resistance (10-6 / °C)		Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance	
		V	±100	100~510k		B(±0.1%)	
		K	±100	10~1M		D(±0.5%)	
		Standard	±200	1.02M~10M	E24. 96		
		K	±100	10~1M		F(±1%)	
RMC1/8	0. 25		+500~-200	1.0~9.76			
			±200	10~10M		G(±2%)	
		Standard	+500~-200	1.0~9.1	E24	G(±2%)	
			±200	10~24M	E24	1/450/\	
			+500~-200	1.0~9.1		J(±5%)	
		K	±100	100~510k	E24. 96	B(±0.1%)	
	0.5	IX.	±100	10~1M		D(±0.5%)	
		Standard	±200	1.02M~10M		F(±1%)	
RMC1/4		K	±100	10~1M			
IXIVIC 1/4		Standard	+500~-200	1.0~9.76			
			ndard ±200	10~10M	E24	G(±2%)	
			±200	10~22M		J(±5%)	
			+500~-200	1.0~9.1		3(±376)	
			K	±100	10~1M	E24, 96	F(±1%)
			+500~-200	1.0~9.76	L24, 90	` ,	
RMC1/2	0. 75	Standard	±200	10~1M		G(±2%)	
		Staridard	1200	10~22M	E24	J(±5%)	
			+500~-200	1.0~9.1		3(±376)	
		K	±100	10~1M	E24, 96	F(±1%)	
			+500~-200	1.0~9.76	E24, 90	F(±1 /0)	
RMC 1	1.0	Standard	.200	10~1M		G(±2%)	
		Standard	±200	10~22M	E24	1/.50/)	
			+500~-200	1.0~9.1	]	J(±5%)	

Style	Limiting element voltage (V)	Insulation voltage (V)	Category temperature range (°C)
RMC1/32	15	50	<i>–</i> 55∼+125
RMC1/20	25	50	
RMC1/16S	50	100	
RMC1/16	75	100	
RMC1/10	150		<i>–</i> 55∼ <b>+</b> 155
RMC1/8			-55*+155
RMC1/4	200	500	
RMC1/2	200		
RMC1			

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 4/18

### 3.2 Chip Jumper

Table-1(3)

Style	Chip jumper symbol	Resistance value of chip jumper	Rated current of chip jumper(A)
RMC1/32			0.5
RMC1/20			1
RMC1/16S			1
RMC1/16			2
RMC1/10	JP	50mΩmax.	2
RMC1/8			2
RMC1/4			2
RMC1/2			2
RMC1			2

#### 3.3 Climatic category

#### 3.3.1 RMC1/32

55/125/56 Lower category temperature -55°C

+125 °C Upper category temperature Duration of the damp heat, steady state test 56days

#### 3.3.2 RMC1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

55/155/56 Lower category temperature -55 °C

> +155 °C Upper category temperature Duration of the damp heat, steady state test 56days

#### 3.4 Stability class

2% Limits for change of resistance:

> -for long-term tests Chip jumper:  $50 \text{ m}\Omega$  max.  $\pm (2\% + 0.1\Omega)$

> > \*RMC1/32. 1/20: ±(3%+0.1Ω)

-for short-term tests  $\pm (0.5\% + 0.05\Omega)$  Chip jumper: 50 m $\Omega$  max.

#### 3.5 Derating

The derated values of dissipation (or current rating in case of chip jumper) at temperature in excess of 70 °C shall be as indicated by the following curve.

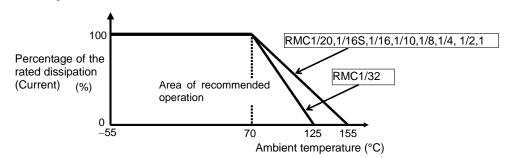


Figure-1 Derating curve

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 5/18

# 3.6 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

E : Rated voltage (V)

E = 
$$\bigvee$$
 P · R

P : Rated dissipation (W)

R : Rated resistance ( $\Omega$ )

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

# 4. Packaging form

The standard packaging form shall be in accordance with Table-2.

#### Table-2

Symbol	Pa	ckaging form	Standard packaging quantity / units	Application				
PA	Press pocket taping	8mm width, 2mm pitches	20,000 pcs.	RMC1/32				
(paper taping)		ornin widin, zmin piiches	15,000 pcs.	RMC1/20				
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RMC1/16S				
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RMC1/16, 1/10, 1/8				
TE	Embassed tening	8mm width, 4mm pitches	4.000 pag	RMC1/4				
15	Embossed taping	12mm width, 4mm pitches	4,000 pcs.	RMC1/2, 1				

#### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

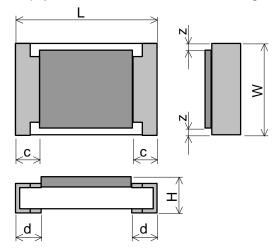


Figure-2

 Table-3
 Unit : mm

 H
 C
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Style	L	W	Н	С	d	Z
RMC1/32	0.4±0.02	0.2±0.02	0.13±0.02	0.08±0.03	0.1±0.03	
RMC1/20	0.6±0.03	0.3±0.03	0.23±0.03	0.1±0.05	0.15±0.05	
RMC1/16S	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.1	0.25 <sup>+0.05</sup> <sub>-0.10</sub>	
RMC1/16	1.6±0.1	$0.8^{+0.15}_{-0.05}$	0.45±0.10	0.3±0.1	0.3±0.1	
RMC1/10	2.0±0.1	1.25±0.10	0.55±0.10	0.4±0.2	0.4±0.2	
RMC1/8	3.1±0.1	1.6±0.15	0.55±0.10	0.5±0.25	0.5±0.25	0.05~0.3
RMC1/4	3.1±0.15	2.5±0.15	0.55±0.15	0.5±0.25	0.5±0.25	0.05~0.3
RMC1/2	5.0±0.15	2.5±0.15	0.55±0.15	0.6±0.2	0.6±0.2	0.05~0.35
RMC1	6.3±0.15	3.2±0.15	0.55±0.15	0.6±0.2	0.6±0.2	0.05~0.35

Product specification contained in this data sheet are subject to change at any time without notice.

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 6/18

### 5.2 Net weight (Reference)

Style	Net weight(mg)
RMC1/32	0.035
RMC1/20	0.16
RMC1/16S	0.6
RMC1/16	2
RMC1/10	5
RMC1/8	9
RMC1/4	16
RMC1/2	25
RMC1	40

#### 6. Marking

The Rated resistance of RMC1/32, 1/20, 1/16S is not be marked.

# 6.1 RMC1/10,1/8,1/4,1/2,1

The nominal resistance shall be marked in 3 digits or 4 digits and marked on over coat side.

• Malaysia products: E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

• China products(RMC1/10,1/8): J(±5%): 3 digits, F(±1%): 4 digits

Marking example		Contents	Application
Malaysia	China	Contents	Application
123	123	12×10 <sup>3</sup> $[\Omega] \rightarrow$ 12 $[k\Omega]$	RMC1/10,1/8,1/4,1/2,1
2R2	2R2	2.2 [Ω]	Less than 10Ω of RMC1/8,1/4,1/2,1
2.2	2R2	2.2 [Ω]	Less than $10\Omega$ of RMC1/10
5623	5623	$562\times10^{3} [\Omega] \rightarrow 562[k\Omega]$	RMC1/10,1/8,1/4,1/2,1
12R7	12R7	12.7 [Ω]	RMC1/10,1/81/4,1/2,1

#### 6.2 RMC1/16

The nominal resistance shall be marked in 3 digits (E24 and/or E96) and marked on over coat side. No marking in the E96 series of a Malaysia.

In case of the resistance value that E96 overlaps with E24, there is a case to mark in E96.

Marking example		Contents	Application	
Malaysia	China	Contents	Application	
123	123	12x10 <sup>3</sup> $[\Omega] \rightarrow$ 12 $[k\Omega]$	E24	
2R2	2R2	2.2 [Ω]	E24	
No marking	02C	$102\times10^2 \left[\Omega\right] \rightarrow 10.2 \text{ [k}\Omega]$	E96	
No marking	51X	$332\times10^{-1} \left[\Omega\right] \rightarrow 33.2 \left[\Omega\right]$	E96	

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 7/18

# 6.2.1 Symbol for E96 series of resistance value

E96	Symbol								
100	01	162	21	261	41	422	61	681	81
102	02	165	22	267	42	432	62	698	82
105	03	169	23	274	43	442	63	715	83
107	04	174	24	280	44	453	64	732	84
110	05	178	25	287	45	464	65	750	85
113	06	182	26	294	46	475	66	768	86
115	07	187	27	301	47	487	67	787	87
118	80	191	28	309	48	499	68	806	88
121	09	196	29	316	49	511	69	825	89
124	10	200	30	324	50	523	70	845	90
127	11	205	31	332	51	536	71	866	91
130	12	210	32	340	52	549	72	887	92
133	13	215	33	348	53	562	73	909	93
137	14	221	34	357	54	576	74	931	94
140	15	226	35	365	55	590	75	953	95
143	16	232	36	374	56	604	76	976	96
147	17	237	37	388	57	619	77		
150	18	243	38	392	58	634	78		
154	19	249	39	402	59	649	79		
158	20	255	40	412	60	665	80		

# 6.2.2 Symbol of multipliers

Symbol	Υ	Х	Α	В	С	D	Е	F
Multipliers	10 <sup>-2</sup>	10 <sup>-1</sup>	10 <sup>0</sup>	10 <sup>1</sup>	10 <sup>2</sup>	10 <sup>3</sup>	10 <sup>4</sup>	10 <sup>5</sup>

# 6.3 Marking example of Jumper Chip

Marking exa	mple	Contents	Application	
Malaysia China		Contents	Application	
O or 000	000		RMC1/16	
0	000	JP	RMC1/10,1/8	
000			RMC1/4,1/2,1	

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 8/18

#### 7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 2011.

7.2 The performance shall be satisfied in Table-4.

Table 4(1)

No	Iable-4(1)							
No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements					
1	Visual examination	Sub-clause 4.4.1	As in 4.4.1					
		Checked by visual examination.	The marking shall be legible, as					
	2:		checked by visual examination.					
2	Dimension	Sub-clause 4.4.2	As specified in Table-3 of this					
	Decistores	0.1.1.45	specification.					
	Resistance	Sub-clause 4.5	As in 4.5.2 The resistance value shall					
			The resistance value shall correspond with the rated resistance					
			taking into account the specified					
			tolerance.					
			Chip jumper: $50m\Omega$ max.					
3	Voltage proof	Sub-clause 4.7	orno jampon comes mexi					
	i siidge produ	Method: 4.6.1.4(See Figure–5)	No breakdown or flash over					
		Test voltage: Alternating voltage with a peak						
		value of 1.42 times the						
		insulation voltage.						
		Duration: $60 \text{ s} \pm 5 \text{ s}$						
		Insulation resistance	R≥1GΩ					
		Test voltage: Insulation voltage						
		Duration: 1 min.						
4	Solderability	Sub-clause 4.17	As in 4.17.4.5					
		Without ageing	The terminations shall be covered					
		Flux: The resistors shall be immersed in a	with a smooth and bright solder coating.					
		non–activated soldering flux for 2s. Bath temperature: $235 ^{\circ}C \pm 5 ^{\circ}C$	Coating.					
		Immersion time: 2 s ± 0.5 s						
5	Mounting	Sub-clause 4.31						
	Widditting	Substrate material: Epoxide woven glass						
		Test substrate: Figure–3						
	Overload	Sub-clause 4.13						
	(in the mounted state)	The applied voltage shall be 2.5 times the						
		rated voltage or twice the limiting element						
		voltage, whichever is the less severe.						
		Duration: 2 s						
		Visual examination	No visible damage					
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$					
	Solvent registered of the		Chip jumper: $50 \text{m}\Omega$ max.					
	Solvent resistance of the marking	Sub-clause 4.30	Legible marking					
	marking	Solvent: 2-propanol						
		Solvent temperature: 23 °C ± 5 °C						
		Method 1						
		Rubbing material: cotton wool Without recovery						
		vviiriout recovery						

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 9/18

Table 4(2)

ce requirements
250)
.05Ω)
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ige such as cracks.
.05Ω)
mΩ max.
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.05Ω)
m $\Omega$ max.
ge
ge
95 05Ω)
m $\Omega$ max.

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 10/18

Table-4(3)

	I	1able-4(3)	
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
9	Climatic sequence	Sub-clause 4.23	
	-Dry heat	Sub-clause 4.23.2	
		RMC1/32 Test temperature: +125 °C	
		RMC1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1:	
		Test temperature: +155 °C	
		Duration: 16 h	
	-Damp heat, cycle	Sub-clause 4.23.3	
	(12+12hour cycle)	Test method: 2	
	First cycle	Test temperature: 55 °C	
		[Severity(2)]	
	-Cold	Sub-clause 4.23.4	
		Test temperature –55 °C	
		Duration: 2h	
	-Damp heat, cycle	Sub-clause 4.23.6	
	(12+12hour cycle)	Test method: 2	
	Remaining cycle	Test temperature: 55 °C	
		[Severity (2)]	
	–D.C. load	Number of cycles: 5 cycles	
	-D.C. load	Sub-clause 4.23.7  The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is	
		the smaller.	
		Duration: 1 min.	
		Visual examination	No visible damage
		Resistance	RMC1/32,1/20: $\Delta R \le \pm (3\% + 0.1\Omega)$
			Others: $\Delta R \le \pm (2\% + 0.1\Omega)$
			Chip jumper: $50m\Omega$ max.
10	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		(RMC1may use Alumina substrate.)	
		Test substrate: Figure–3	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C ± 2 °C	
		Duration: 1000 h	
		The voltage shall be applied in cycles of 1.5 h	
		on and 0.5 h off.	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is	
		the smaller.	
		Examination at 48 h, 500 h and	
		1000 h:	No visible damage
		Visual examination	RMC1/32,1/20: $\Delta R \le \pm (3\% + 0.1\Omega)$
		Resistance	Others: $\Delta R \le \pm (3\% + 0.152)$
			Chip jumper: $50m\Omega$ max.
			Onip Jamper, Johns Max.

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Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

Table-4(4)

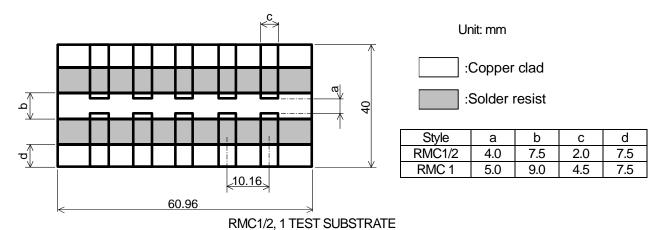
	T =	1able 4(4)	
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
11	Mounting  Variation of resistance with temperature	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.8 RMC1/32:	As in Table–1
12	Mounting  Damp heat, steady state	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.24 Ambient temperature: 40 °C ± 2 °C Relative humidity: 93 ½ % a) 1st group: without voltage applied. b) 2nd group: The d. c. voltage shall be applied continuously. The voltage shall be accordance with Sub-clause 4.24.2.1 b). without polarizing voltage [4.24.2.1, c)] Visual examination Resistance	No visible damage Legible marking RMC1/32,1/20: $\Delta R \le \pm (3\%+0.1\Omega)$ Others: $\Delta R \le \pm (2\%+0.1\Omega)$ Chip jumper: $50m\Omega$ max.
13	Dimensions (detail)  Mounting  Endurance at upper category temperature	Sub-clause 4.4.3  Sub-clause 4.31  Substrate material: Epoxide woven glass Test substrate: Figure–3  Sub-clause 4.25.3  RMC1/32:  Ambient temperature:125 °C ± 2 °C  RMC1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1:  Ambient temperature:155 °C ± 2 °C  Duration: 1000 h  Examination at 48 h, 500 h and 1000 h:  Visual examination  Resistance	As in Table–3  No visible damage RMC1/32,1/20: $\Delta R \le \pm (3\%+0.1\Omega)$ Others: $\Delta R \le \pm (2\%+0.1\Omega)$ Chip jumper: $50m\Omega$ max.

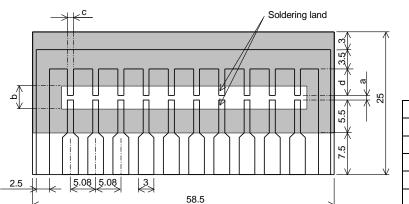
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FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

#### 8. Test substrate





ι	Jnit: mm
	:Copper clad
	:Solder resist

Style	а	b	С	d
RMC1/32	0.2	0.56	0.2	5.3
RMC1/20	0.3	1.5	0.45	5.2
RMC1/16S	0.6	1.9	0.7	4.9
RMC1/16	1.0	3.6	1.0	4.5
RMC1/10	1.2	4.0	1.5	4.3
RMC1/8	2.1	3.9	1.7	3.4
RMC1/4	2.2	5.0	2.9	3.3

RMC1/20, 1/16S, 1/16, 1/10, 1/8, 1/4 TEST SUBSTRATE Figure-3

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.

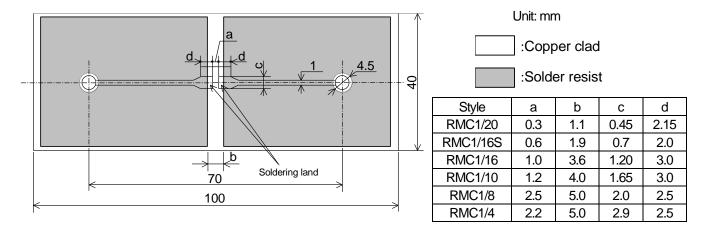
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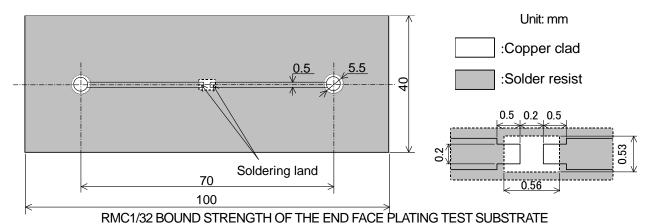
FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

Unit: mm :Copper clad 8 :Solder resist Style b а С RMC1/2 4.0 7.5 3.0 b RMC<sub>1</sub> 5.0 9.0 4.0 100

RMC1/2, 1 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE



# RMC1/20,1/16S,1/16,1/10,1/8,1/4 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

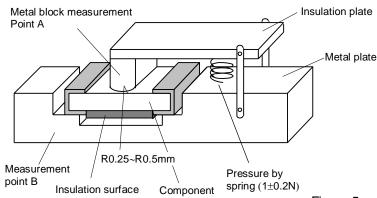


Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm Figure-4

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 14/18

# · RMC1/16S,1/16,1/10,1/8,1/4,1/2,1



· RMC1/32, 1/20

Figure-5

#### 9. Taping

- 9.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 9.2 Taping dimensions
- 9.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-6 and Table-5.

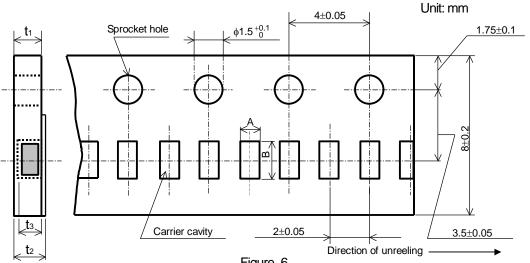


Figure-6

Table-5					Unit: mm
Style	Α	В	t <sub>1</sub>	t <sub>2</sub>	t <sub>3</sub>
RMC1/32	0.24±0.03	0.45±0.03	0.31±0.03	0.36±0.03	0.15±0.02
RMC1/20	0.37±0.05	0.67±0.05	0.42±0.03	0.45±0.05	0.27±0.02

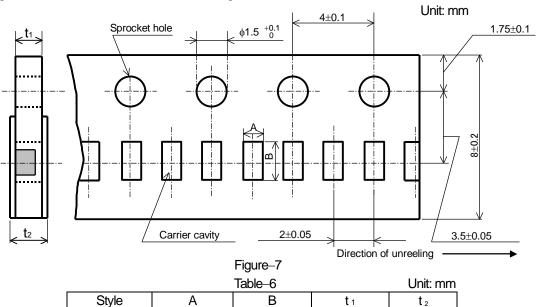
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FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

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# 9.2.2 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-7 and Table-6.



	Unit: mm			
Style	Α	В	<b>t</b> 1	t <sub>2</sub>
RMC1/16S	$0.65^{+0.05}_{-0.10}$	1.15 <sup>+0.05</sup> <sub>-0.10</sub>	$0.4 \pm 0.05$	0.5max.

#### 9.2.3 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-8 and Table-7.

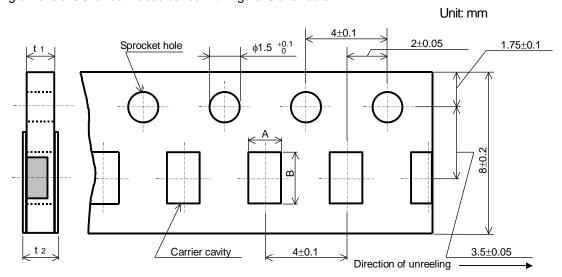


Figure-8

	Unit: mm				
Style	Α	В	<b>t</b> 1	<b>t</b> 2	
RMC1/16	1.15±0.15	1.9±0.2	0.6±0.1	0.8max.	
RMC1/10	1.65±0.15	2.5±0.2	0.8±0.1	1.0may	
RMC1/8	2.00±0.15	3.6±0.2	U.0±U.1	1.0max.	

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

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#### 9.2.4 Embossed taping dimensions shall be in accordance with Figure-9 and Table-8.

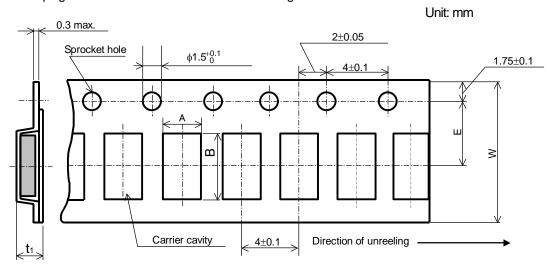


Figure-9

	Unit: mm	1				
Style	Α	В	W	E	<b>t</b> 1	
RMC1/4	2.85±0.20	3.5±0.2	8.0±0.3	3.5±0.05	1.0±0.2	
RMC1/2	3.1±0.2	5.5±0.2	12.0±0.3	E E . O OE	11.015	
RMC 1	3.6±0.2	6.9±0.2		5.5±0.05	1.1±0.15	

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RMC1/32,1/20: Figure–10, RMC1/16S, 1/16, 1/10, 1/8: Figure–11, RMC1/4, 1/2, 1: Figure–12.
- 6). When the tape is bent with the minimum radius for RMC1/32, 1/20, 1/16S, 1/16, 1/10,1/8, 1/4: 25 mm, or RMC1/2, 1: 30 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- In no case shall there be two or more consecutive components missing.
   The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

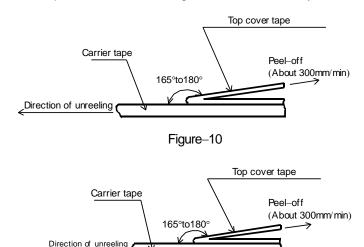
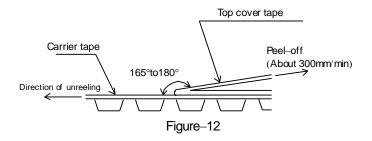


Figure-11

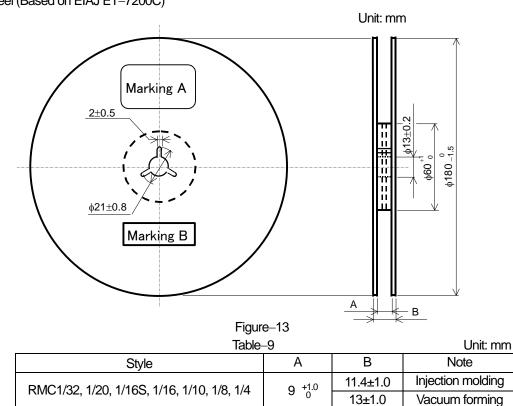
FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1

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#### 9.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-13 and Table-9. Plastic reel (Based on EIAJ ET-7200C)

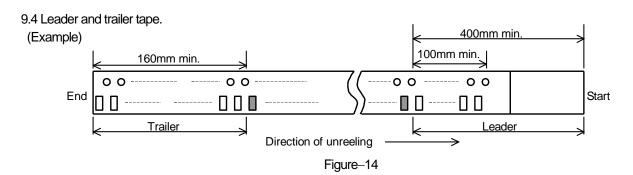


13 <sup>+1.0</sup> Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

17±1.0

Vacuum forming

RMC1/2, 1





RMC-K-HTS-0006 /14

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE

RMC1/32,1/20,1/16S,1/16,1/10,1/8,1/4,1/2,1 Page: 18/18

#### 10. Marking on package

The label of a minimum package shall be legibly marked with follows.

# 10.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

10.2 Marking B (KAMAYA Control label)